

Serial No. 10/701,441

Attorney Docket No. 01-304-DIV

REMARKS

Claims 1-17 and 20-22 are pending. Claims 18, 19 and 23-30 have been canceled. The applicants respectfully request reconsideration and allowance of this application in view of the above amendments and the following remarks.

The office action stated that the abstract should be revised to reflect the method instead of the product. The abstract has been so amended.

Claims 14-19 were rejected under 35 USC 102(e) as being anticipated by Kurita *et al.* The applicants respectfully request that this rejection be withdrawn for the following reasons.

One feature of claim 14 is that a stacked body is formed by a plurality of conductive layer films and a sheet member, and no conductive layer and no bottomed via-hole is formed in the sheet member. Since the sheet member is used for exclusively accommodating an electric device in the recess or opening, an adverse influence caused by contraction of the resin is limited.

For example, in the case that a via-hole is formed in the sheet member, contraction of the conductive paste as well as the via-hole may affect the contraction of the recess or the opening. Furthermore, the conductive layer, if any, may also affect the contraction of the recess or the opening.

With the method of claim 14, however, the positioning of the electric device can be easily done by simply inserting the electric device into the recess or the opening.

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Such an electric device, which has a larger size, can be accommodated in the recess or the opening. In other words, the size of the recess or the opening can be made larger, compared with the case in which the via-hole is formed in the sheet member.

The electric device can be more positively sealed by the method of claim 14, because the flow of resin in the sheet member is not affected in the process of contraction by any via-holes or conductive layers.

Claim 14, as amended, is not anticipated by Kurita *et al.* Kurita *et al.* discloses, as mentioned by the examiner in the office action, sheet members 11 to 13 for which an opening 26 is formed. Furthermore, via-holes and conductive bumps are formed in those sheet members 11 to 13. Accordingly, Kurita *et al.* does not disclose nor suggest a sheet member in which no conductive layer and no bottomed via-hole is formed in the sheet member. Therefore, this rejection should be withdrawn.

Claim 20 was rejected under 35 USC 103(a) as being unpatentable over Kurita *et al.* Claims 20-22 was rejected under 35 USC 103(a) as being unpatentable over Kurita *et al.* in view of the Japanese publication JP11233904A. The applicants respectfully request that these rejections be withdrawn for the following reasons.

Claims 20-22 are dependent on claim 14, directly or indirectly. Therefore, claims 20-22 are considered to be patentable based on the patentability of their base claim. Furthermore the Japanese publication JP11233904A fails to supply what is missing in Kurita *et al.* Therefore, this rejection should be withdrawn.

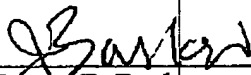
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In view of the foregoing, the applicants submit that this application is in condition for allowance. A timely notice to that effect is respectfully requested. If questions relating to patentability remain, the examiner is invited to contact the undersigned by telephone.

If there are any problems with the payment of fees, please charge any underpayments and credit any overpayments to Deposit Account No. 50-1147.

Respectfully submitted,


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